Tower Semiconductor
Where **Analog** and **Value** Meet

2025 MPW schedule

Last updated: February 26, 2025

MPW name	**Fab**	**Processes**	**Tape-In**	**Ship Date**
PH18DA - B5614	**NPB - Fab 3**	SiPho 0.18um	**8-20-24**	**8-7-25**
PH18M* - B5617	**NPB - Fab 3**	SiPho 0.18um	**9-10-24**	**5-5-25**
SB*18 - B5619	**NPB - Fab 3**	SiGe BiCMOS 0.18um	**10-08-24**	**4-28-25**
CS18* - B5616	**MH - Fab 2**	CMOS-SOI 0.18um	**10-29-24**	
CA18 - B5621	**NPB - Fab 3**	RFCMOS 0.18um	**11-05-24**	**4-29-25**
SB*18 - B5622	**NPB - Fab 3**	SiGe BiCMOS 0.18um	**11-19-24**	**6-20-25**
SB*18 – B6000	**NPB - Fab 3**	SiGe BiCMOS 0.18um	**1-14-25**	**8-27-25**
Q1 2025	**NM - Fab 11**	TPS65MSPM	**2-04-25**	
CA18 - B6002	**NPB - Fab 3**	RFCMOS 0.18um	**2-11-25**	**8-21-25**
32nd MPW - Tonami, Japan	**TPSCo - Fab 5**	CMOS 0.18u & 0.16u, PM, PM_SOI	**2-25-25**	
PH18M* - B6003	**NPB - Fab 3**	SiPho 0.18um	**2-25-25**	**10-20-25**
1st MPW RFSOI-RSM5T	**TSIT - Fab 10**	90RSC/65RSA2/65RSB2/65RSC	**3-10-25**	
34th MPW - Uozu, Japan	**TPSCo - Fab 7**	CMOS, PM, RFCMOS & SiGe, 65nm : TPS65SLA/SLC, TPS65PMA/PMB/PMK/MSA/MSB/MSK, TPS65RF, TPS65SG	**3-24-25**	
PH18DA - B6006	**NPB - Fab 3**	SiPho 0.18um	**3-25-25**	**3-12-26**
SB*18 - B6007	**TJT - Fab 9**	SiGe BiCMOS 0.18um	**4-08-25**	
SH125T18APRIL	**MH - Fab 2**	CIS 0.18u Image Sensor CMOS+ 0.16u, 0.18u RF, RFID, PM	**4-10-25** **4-17-25**	
35th MPW - Uozu, Japan	**TPSCo - Fab 7**	300mm Silicon Photonics: TPS45PHD	**4-14-25**	
SBC18HE5PCA - B6008	**NPB - Fab 3**	SiGe BiCMOS 0.18um with PCM RF Switch	**4-22-25**	
CA18 - B6009	**NPB - Fab 3**	RFCMOS 0.18um	**5-06-25**	**11-13-25**
Q2 2025	**NM - Fab 11**	TPS65MSPM	**5-15-25**	
PH18M* - B6010	**NPB - Fab 3**	SiPho 0.18um	**5-20-25**	**1-12-26**
33rd MPW - Tonami, Japan	**TPSCo - Fab 5**	CMOS 0.18u & 0.16u, PM, PM_SOI	**5-26-25**	
SB*18 - B6011	**NPB - Fab 3**	SiGe BiCMOS 0.18um	**6-03-25**	**12-22-25**
CS18* - B6012	**MH - Fab 2**	CMOS-SOI 0.18um	**6-17-25**	
SB*/CA13* - B6013	**NPB - Fab 3**	SiGe BiCMOS/RF CMOS 0.13um	**7-01-25**	**3-3-26**
SBC18HE5PCA - B6014	**NPB - Fab 3**	SiGe BiCMOS 0.18um with PCM RF Switch	**7-15-25**	
SB*18 - B6015	**NPB - Fab 3**	SiGe BiCMOS 0.18um	**7-29-25**	**2-16-26**
PH18DA - B6016	**NPB - Fab 3**	SiPho 0.18um	**8-12-25**	**7-30-26**

MPW name	Fab	Processes	Tape-In	Ship Date
Q3 2025	**NM - Fab 11**	TPS65MSPM	**8-15-25**	
34th MPW - Tonami, Japan	**TPSCo - Fab 5**	CMOS 0.18u & 0.16u, PM, PM_SOI	**8-25-25**	
CA18 - B6017	**NPB - Fab 3**	RFCMOS 0.18um	**8-26-25**	**2-06-26**
2nd MPW RFSOI-RSS5T	**TSIT - Fab 10**	90RSC/65RSA2/65RSB2/65RSC	**9-8-25**	
PH18M* - B6019	**NPB - Fab 3**	SiPho 0.18um	**9-23-25**	**5-18-26**
36th MPW - Uozu, Japan	**TPSCo - Fab 7**	CMOS, PM, RFCMOS & SiGe, 65nm : TPS65SLA/SLC, TPS65PMA/PMB/PMK/MSA/MSB/MSK, TPS65RF, TPS65SG	**9-29-25**	
SB*18 - B6020	**NPB - Fab 3**	SiGe BiCMOS 0.18um	**10-07-25**	**4-16-26**
SBC18HE5PCA - B6021	**NPB - Fab 3**	SiGe BiCMOS 0.18um with PCM RF Switch	**10-21-25**	
37th MPW - Uozu, Japan	**TPSCo - Fab 7**	300mm Silicon Photonics: TPS45PHD	**10-27-25**	
PH18M* - B6022	**NPB - Fab 3**	SiPho 0.18um	**10-28-25**	**6-22-26**
Q4 2025	**NM - Fab 11**	TPS65MSPM	**11-14-25**	
SH225T18NOV	**MH - Fab 2**	CIS 0.18u Image Sensor CMOS+ 0.16u, 0.18u RF, RFID, PM	**11-17-25** **11-23-25**	
35th MPW - Tonami, Japan	**TPSCo - Fab 5**	CMOS 0.18u & 0.16u, PM, PM_SOI	**11-25-25**	
CS18* - B6023	**MH - Fab 2**	CMOS-SOI 0.18um	**1-6-26**	

Notes: "Shuttles" (SH*) are run at Fab 2

* 0.13u MH – fab 2 Shuttle / MPW slots will be considered per needs

Please contact your customer account manager for additional information.

Fab2 - Tower Semiconductor 200mm wafer fabrication facility at Migdal Ha'emek, Israel

Fab3 - Tower Semiconductor 200mm wafer fabrication facility at Newport Beach, CA

Fab5 - Tower Semiconductor 200mm wafer fabrication facility at Tonami, Japan

Fab7 - Tower Semiconductor 300mm wafer fabrication facility at Uozu, Japan

Fab9 - Tower Semiconductor 200mm wafer fabrication facility at San Antonio, TX

Fab10 - Tower Semiconductor 300mm wafer fabrication facility at Agrate, Italy

Fab11 - Tower Semiconductor 300mm wafer fabrication facility at Rio Rancho, NM